

# SPN6335

## DESCRIPTION

The SPN6335 is the Dual N-Channel enhancement mode power field effect transistors are produced using high cell density , DMOS trench technology. This high density process is especially tailored to minimize on-state resistance and provide superior switching performance. These devices are particularly suited for low voltage applications such as notebook computer power management and other battery powered circuits where high-side switching , low in-line power loss, and resistance to transients are needed.

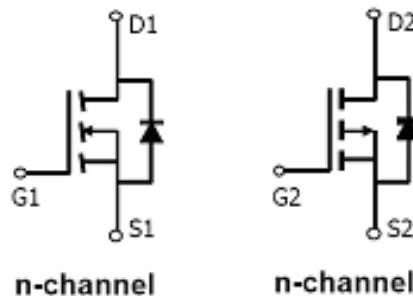
## FEATURES

- ◆ N-Channel
  - 20V/0.95A,RDS(ON)=380mΩ@VGS=4.5V
  - 20V/0.75A,RDS(ON)=450mΩ@VGS=2.5V
  - 20V/0.65A,RDS(ON)=800mΩ@VGS=1.8V
- ◆ Super high density cell design for extremely low RDS (ON)
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ SOT-363 (SC-70-6L) package design

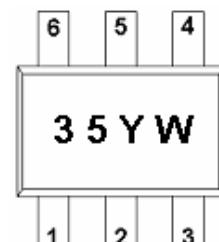
## APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

## PIN CONFIGURATION( SOT-363 / SC-70-6L)



## PART MARKING



Y : Year Code  
W: Week Code

# SPN6335

## PIN DESCRIPTION

Pin	Symbol	Description
1	G1	Gate 1
2	S2	Source 2
3	G2	Gate 2
4	D2	Drain 2
5	S1	Source 1
6	D1	Drain1

## ORDERING INFORMATION

Part Number	Package	Part Marking
SPN6335S36RG	SOT-363	35YW

※ Week Code : A ~ Z( 1 ~ 26 ) ; a ~ z( 27 ~ 52 )

※ SPN6335S36RG : Tape Reel ; Pb – Free

## ABSOLUTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V <sub>DSS</sub>	20	V
Gate –Source Voltage	V <sub>GSS</sub>	±12	V
Continuous Drain Current(T <sub>J</sub> =150°C)	T <sub>A</sub> =25°C	ID	A
	T <sub>A</sub> =80°C		
Pulsed Drain Current	I <sub>DM</sub>	4	A
Continuous Source Current(Diode Conduction)	I <sub>S</sub>	0.6	A
Power Dissipation	T <sub>A</sub> =25°C	P <sub>D</sub>	W
	T <sub>A</sub> =70°C		
Operating Junction Temperature	T <sub>J</sub>	-55/150	°C
Storage Temperature Range	T <sub>STG</sub>	-55/150	°C
Thermal Resistance-Junction to Ambient	T ≤ 10sec	R <sub>θJA</sub>	°C/W
	Steady State		
		360	
		400	

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## ELECTRICAL CHARACTERISTICS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0V, ID= 250uA	20			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , ID=250uA	0.35		1.0	
Gate Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±12V			100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 20V, V <sub>GS</sub> =0V			1	uA
		V <sub>DS</sub> = 20V, V <sub>GS</sub> =0V T <sub>J</sub> =55°C			5	
On-State Drain Current	I <sub>D(on)</sub>	V <sub>DS</sub> ≥ 4.5V, V <sub>GS</sub> =5V	2			A
Drain-Source On-Resistance	R <sub>DSS(on)</sub>	V <sub>GS</sub> =4.5V, ID=0.95A		0.26	0.38	Ω
		V <sub>GS</sub> =2.5V, ID=0.75A		0.32	0.45	
		V <sub>GS</sub> =1.8V, ID=0.65A		0.42	0.80	
Forward Transconductance	g <sub>fs</sub>	V <sub>DS</sub> =10V, ID=1.2A		2.6		S
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =0.5A, V <sub>GS</sub> =0V		0.8	1.2	V
<b>Dynamic</b>						
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =10V, V <sub>GS</sub> =4.5V, ID=0.7A		1.2	1.5	nC
Gate-Source Charge	Q <sub>gs</sub>			0.2		
Gate-Drain Charge	Q <sub>gd</sub>			0.3		
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =10V, V <sub>GS</sub> =0V f=1MHz		110		pF
Output Capacitance	C <sub>oss</sub>			34		
Reverse Transfer Capacitance	C <sub>rss</sub>			16		
Turn-On Time	t <sub>d(on)</sub>	V <sub>DD</sub> =10V, R <sub>L</sub> =10Ω , ID=1.0A V <sub>GEN</sub> =4.5V , R <sub>G</sub> =6Ω		5	10	ns
	t <sub>r</sub>			8	15	
Turn-Off Time	t <sub>d(off)</sub>			10	18	
	t <sub>f</sub>			1.2	2.8	